

The TRENCHSTOP™ 5 WR6 family in the TO-247-3-HCC package offers improved reliability against package contamination

Features

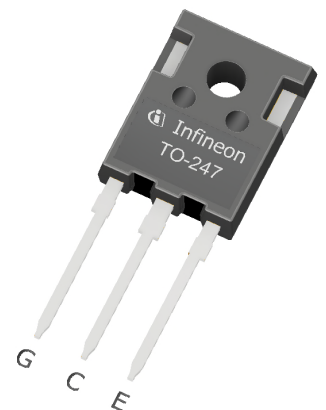
- $V_{CE} = 650\text{ V}$
- $I_C = 70\text{ A}$
- Pin-to-pin creepage distance > 4.8 mm
- Pin-to-pin clearance distance > 3.4 mm
- Monolithic diode optimized for PFC and welding applications
- Stable temperature behavior
- Very low V_{CEsat} and low E_{off}
- Easy parallel switching capability based on positive temperature coefficient of V_{CEsat}
- Low temperature dependence of V_{CEsat} and E_{sw}
- Product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

Potential applications

- PFC
- Welding
- ZCS applications

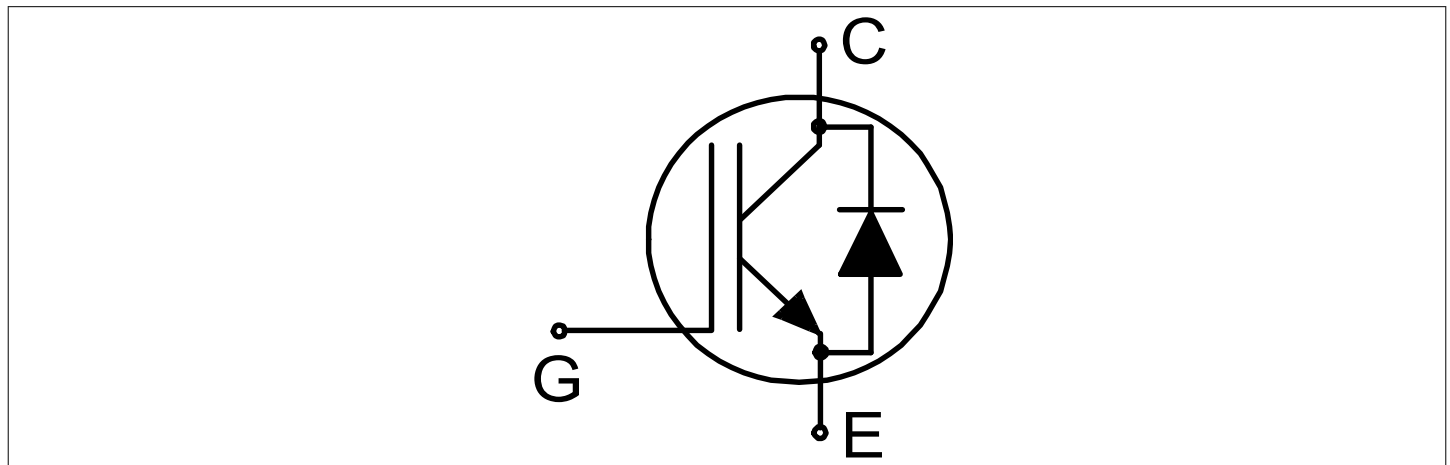
Product validation

- Product Validation: Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



- Lead-Free
- Green
- Halogen-Free
- RoHS

Description



| Type | Package | Marking |
|--------------|----------------|---------|
| IKWH70N65WR6 | PG-TO247-3-HCC | H70EWR6 |

Table of contents

| | | |
|----------|---------------------------------------|----|
| | Description | 1 |
| | Features | 1 |
| | Potential applications | 1 |
| | Product validation | 1 |
| | Table of contents | 2 |
| 1 | Package | 3 |
| 2 | IGBT | 3 |
| 3 | Diode | 5 |
| 4 | Characteristics diagrams | 7 |
| 5 | Package outlines | 14 |
| 6 | Testing conditions | 15 |
| | Revision history | 16 |
| | Disclaimer | 17 |

1 Package

1 Package

Table 1 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|--|---------------|--|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Internal emitter inductance measured 5 mm (0.197 in) from case | L_E | | | 13.0 | | nH |
| Storage temperature | T_{stg} | | -55 | | 150 | °C |
| Soldering temperature | | wave soldering 1.6 mm (0.063 in.) from case for 10 s | | | 260 | °C |
| Mounting torque, M3 screw Maximum of mounting processes: 3 | M | | | | 0.6 | Nm |
| Thermal resistance, junction-ambient | $R_{th(j-a)}$ | | | | 40 | K/W |

2 IGBT

Table 2 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|--|-------------|--|-----------------------|------|---|
| Collector-emitter voltage | V_{CE} | $T_{vj} \geq 25\text{ °C}$ | 650 | V | |
| DC collector current, limited by T_{vjmax} | I_C | | $T_C = 25\text{ °C}$ | 122 | A |
| | | | $T_C = 100\text{ °C}$ | 70 | |
| Pulsed collector current, t_p limited by T_{vjmax} | I_{Cpuls} | | 210 | A | |
| Turn-off safe operating area | | $V_{CE} \leq 650\text{ V}, t_p \leq 1\text{ }\mu\text{s}, T_{vj} \leq 175\text{ °C}$ | 210 | A | |
| Gate-emitter voltage | V_{GE} | | ± 20 | V | |
| Transient gate-emitter voltage | V_{GE} | $t_p \leq 10\text{ }\mu\text{s}, D < 0.010$ | ± 20 | V | |
| Power dissipation | P_{tot} | | $T_C = 25\text{ °C}$ | 290 | W |
| | | | $T_C = 100\text{ °C}$ | 145 | |

Table 3 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|--------------------------------------|---------------------|---|--------------------------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Collector-emitter breakdown voltage | V_{BRCES} | $I_C = 0.2\text{ mA}, V_{GE} = 0\text{ V}$ | 650 | | | V |
| Collector-emitter saturation voltage | $V_{CE\text{ sat}}$ | $I_C = 70.0\text{ A}, V_{GE} = 15\text{ V}$ | $T_{vj} = 25\text{ °C}$ | 1.55 | 1.85 | V |
| | | | $T_{vj} = 175\text{ °C}$ | 1.80 | | |

Table 3 Characteristic values (continued)

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|-------------------------------------|------------|---|--|------|------|---------------|
| | | | Min. | Typ. | Max. | |
| Gate-emitter threshold voltage | V_{GEth} | $I_C = 0.70 \text{ mA}, V_{CE} = V_{GE}$ | 3.20 | 4.00 | 4.80 | V |
| Zero gate voltage collector current | I_{CES} | $V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$ | $T_{vj} = 25 \text{ }^\circ\text{C}$ | | 40 | μA |
| | | | $T_{vj} = 175 \text{ }^\circ\text{C}$ | | 0.5 | mA |
| Gate-emitter leakage current | I_{GES} | $V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$ | | | 100 | nA |
| Transconductance | g_{fs} | $I_C = 70.0 \text{ A}, V_{CE} = 20 \text{ V}$ | | 155 | | S |
| Input capacitance | C_{ies} | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$ | | 5320 | | pF |
| Output capacitance | C_{oes} | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$ | | 52 | | pF |
| Reverse transfer capacitance | C_{res} | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$ | | 22 | | pF |
| Gate charge | Q_G | $I_C = 70.0 \text{ A}, V_{GE} = 15 \text{ V}, V_{CE} = 520 \text{ V}$ | | 269 | | nC |
| Turn-on delay time | t_{don} | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 15.0 \text{ } \Omega,$ $R_{Goff} = 15.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 20 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 42 | ns |
| | | | $T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 39 | |
| Rise time (inductive load) | t_r | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 15.0 \text{ } \Omega,$ $R_{Goff} = 15.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 20 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 31 | ns |
| | | | $T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 33 | |
| Turn-off delay time | t_{doff} | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 15.0 \text{ } \Omega,$ $R_{Goff} = 15.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 20 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 378 | ns |
| | | | $T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 423 | |
| Fall time (inductive load) | t_f | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 15.0 \text{ } \Omega,$ $R_{Goff} = 15.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 20 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 26 | ns |
| | | | $T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 20 | |
| Turn-on energy | E_{on} | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 15.0 \text{ } \Omega,$ $R_{Goff} = 15.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 20 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 2.20 | mJ |
| | | | $T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 2.35 | |
| Turn-off energy | E_{off} | $V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V},$ $R_{Gon} = 15.0 \text{ } \Omega,$ $R_{Goff} = 15.0 \text{ } \Omega,$ $L_\sigma = 30 \text{ nH}, C_\sigma = 20 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 1.07 | mJ |
| | | | $T_{vj} = 175 \text{ }^\circ\text{C},$ $I_C = 70.0 \text{ A}$ | | 1.48 | |

Table 3 Characteristic values (continued)

| Parameter | Symbol | Note or test condition | Values | | | Unit | |
|--|------------|--|---|------|------|--------------------|----|
| | | | Min. | Typ. | Max. | | |
| Total switching energy | E_{ts} | $V_{CE} = 400\text{ V}$, $V_{GE} = 15\text{ V}$, $R_{Gon} = 15.0\ \Omega$, $R_{Goff} = 15.0\ \Omega$, $L_{\sigma} = 30\text{ nH}$, $C_{\sigma} = 20\text{ pF}$ | $T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_C = 70.0\text{ A}$ | | 3.26 | | mJ |
| | | | $T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_C = 70.0\text{ A}$ | | 3.83 | | |
| IGBT thermal resistance, junction-case | R_{thjc} | | | | 0.50 | K/W | |
| Operating junction temperature | T_{vj} | | -40 | | 175 | $^{\circ}\text{C}$ | |

Note: Electrical Characteristic, at $T_{vj} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified.

3 Diode

Table 4 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|---|-------------|--|-------------------------------------|------|---|
| Repetitive peak reverse voltage | V_{RRM} | $T_{vj} \geq 25\text{ }^{\circ}\text{C}$ | 650 | V | |
| Diode forward current, limited by T_{vjmax} | I_F | | $T_C = 25\text{ }^{\circ}\text{C}$ | 37 | A |
| | | | $T_C = 100\text{ }^{\circ}\text{C}$ | 22 | |
| Diode pulsed current, limited by T_{vjmax} | I_{Fpuls} | | 70 | A | |

Table 5 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit | |
|-----------------------------|----------|------------------------|---|------|------|------|----|
| | | | Min. | Typ. | Max. | | |
| Diode forward voltage | V_F | $I_F = 21.5\text{ A}$ | $T_{vj} = 25\text{ }^{\circ}\text{C}$ | | 1.30 | 1.60 | V |
| | | | $T_{vj} = 175\text{ }^{\circ}\text{C}$ | | 1.35 | | |
| Diode reverse recovery time | t_{rr} | $V_R = 400\text{ V}$ | $T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_F = 35.0\text{ A}$, $-di_F/dt = 1870\text{ A}/\mu\text{s}$ | | 98 | | ns |
| | | | $T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_F = 35.0\text{ A}$, $-di_F/dt = 1800\text{ A}/\mu\text{s}$ | | 120 | | |

Table 5 Characteristic values (continued)

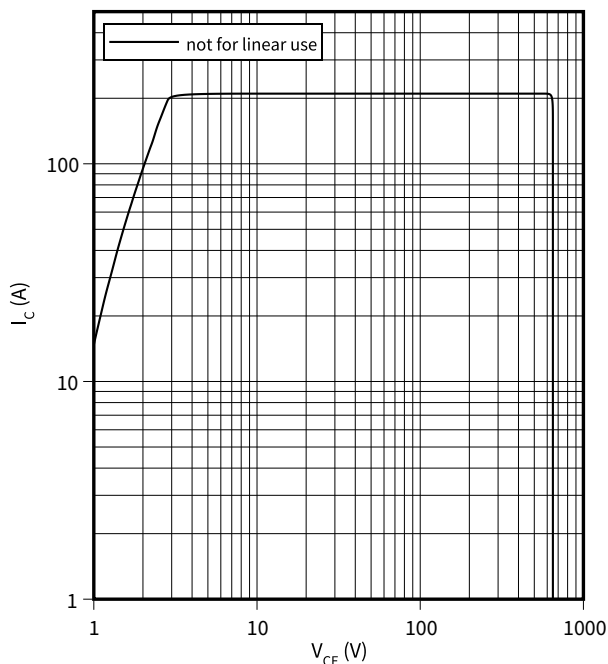
| Parameter | Symbol | Note or test condition | | Values | | | Unit |
|--|--------------|------------------------|---|--------|------|------|------------------------|
| | | | | Min. | Typ. | Max. | |
| Diode reverse recovery charge | Q_{rr} | $V_R = 400\text{ V}$ | $T_{vj} = 25\text{ °C}$, $I_F = 35.0\text{ A}$, $-di_F/dt = 1870\text{ A}/\mu\text{s}$ | | 2.80 | | μC |
| | | | $T_{vj} = 175\text{ °C}$, $I_F = 35.0\text{ A}$, $-di_F/dt = 1800\text{ A}/\mu\text{s}$ | | 4.50 | | |
| Diode peak reverse recovery current | I_{rrm} | $V_R = 400\text{ V}$ | $T_{vj} = 25\text{ °C}$, $I_F = 35.0\text{ A}$, $-di_F/dt = 1870\text{ A}/\mu\text{s}$ | | 40.3 | | A |
| | | | $T_{vj} = 175\text{ °C}$, $I_F = 35.0\text{ A}$, $-di_F/dt = 1800\text{ A}/\mu\text{s}$ | | 59.0 | | |
| Diode peak rate off fall of reverse recovery current | di_{rr}/dt | $V_R = 400\text{ V}$ | $T_{vj} = 25\text{ °C}$, $I_F = 35.0\text{ A}$, $-di_F/dt = 1870\text{ A}/\mu\text{s}$ | | -700 | | $\text{A}/\mu\text{s}$ |
| | | | $T_{vj} = 175\text{ °C}$, $I_F = 35.0\text{ A}$, $-di_F/dt = 1800\text{ A}/\mu\text{s}$ | | -866 | | |
| Diode thermal resistance, junction-case | R_{thjc} | | | | | 1.90 | K/W |
| Operating junction temperature | T_{vj} | | | -40 | | 175 | $^{\circ}\text{C}$ |

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

4 Characteristics diagrams

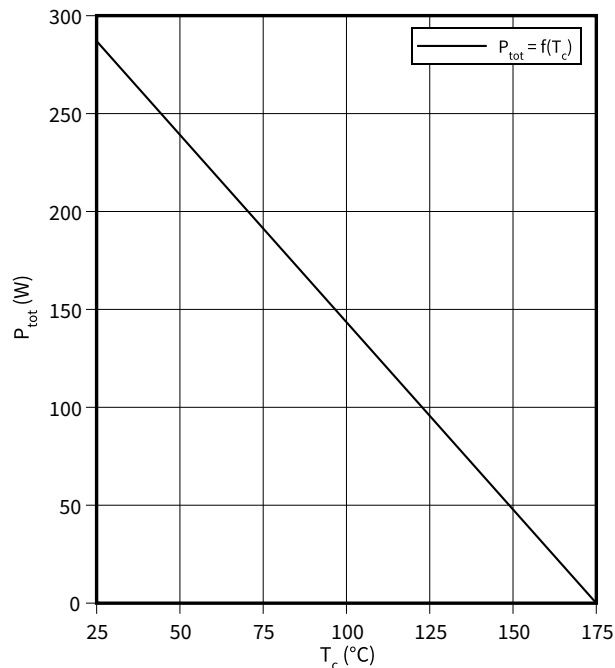
Forward bias safe operating area, IGBT

$I_C = f(V_{CE})$
 $t_p = 1 \mu s, D = 0, T_{vj} \leq 175 \text{ }^\circ\text{C}, T_C = 25 \text{ }^\circ\text{C}, V_{GE} = 15 \text{ V}$



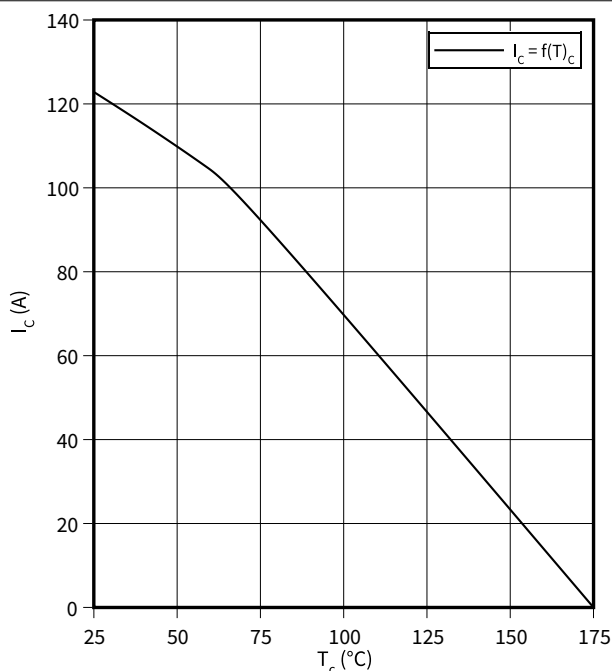
Power dissipation as a function of case temperature, IGBT

$P_{tot} = f(T_c)$
 $T_{vj} \leq 175 \text{ }^\circ\text{C}$



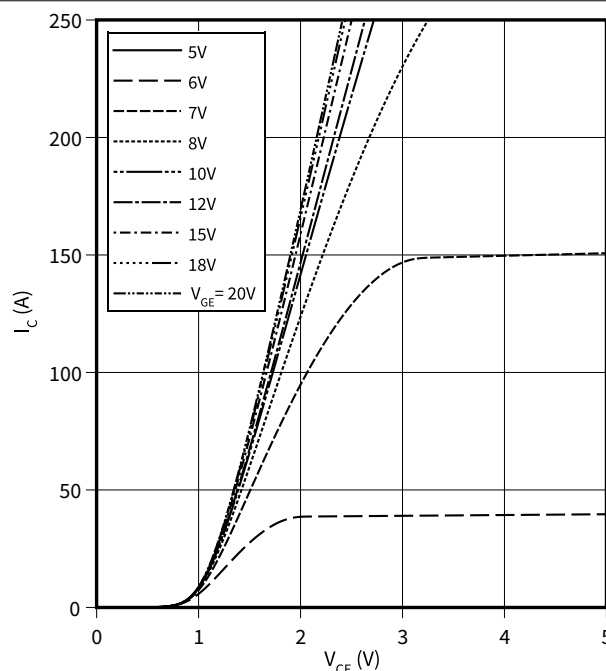
Collector current as a function of case temperature, IGBT

$I_C = f(T_c)$
 $V_{GE} \geq 15 \text{ V}, T_{vj} \leq 175 \text{ }^\circ\text{C}$



Typical output characteristic, IGBT

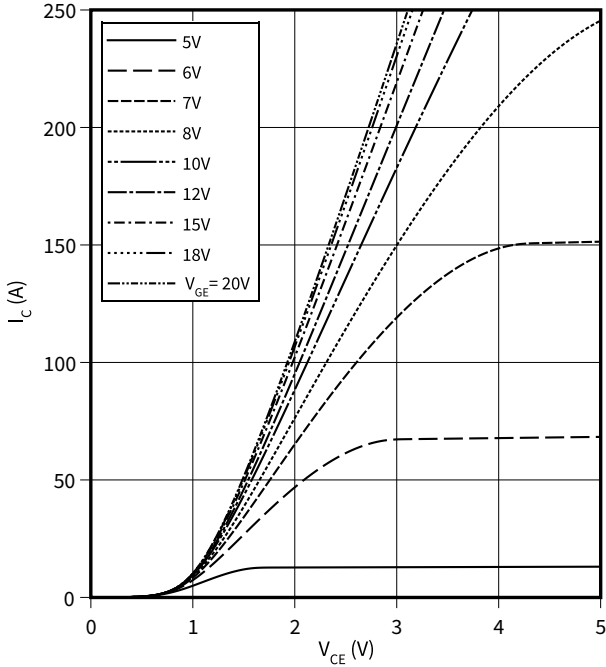
$I_C = f(V_{CE})$
 $T_{vj} = 25 \text{ }^\circ\text{C}$



4 Characteristics diagrams

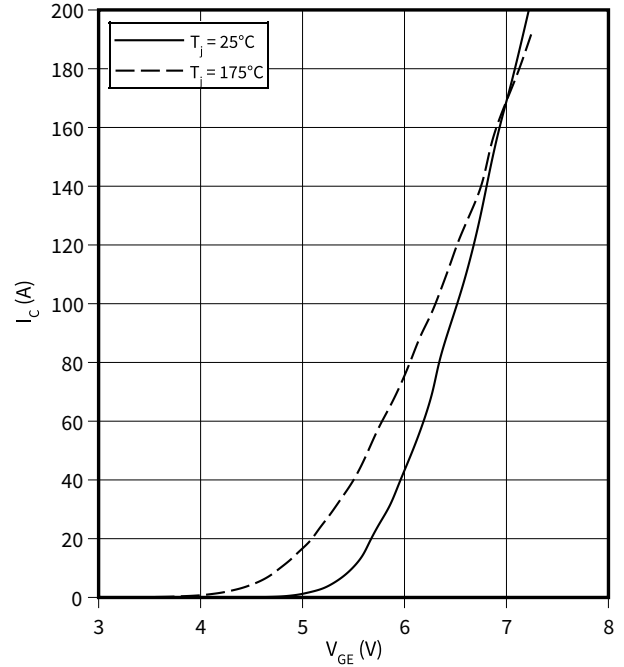
Typical output characteristic, IGBT

$I_C = f(V_{CE})$
 $T_{vj} = 175\text{ °C}$



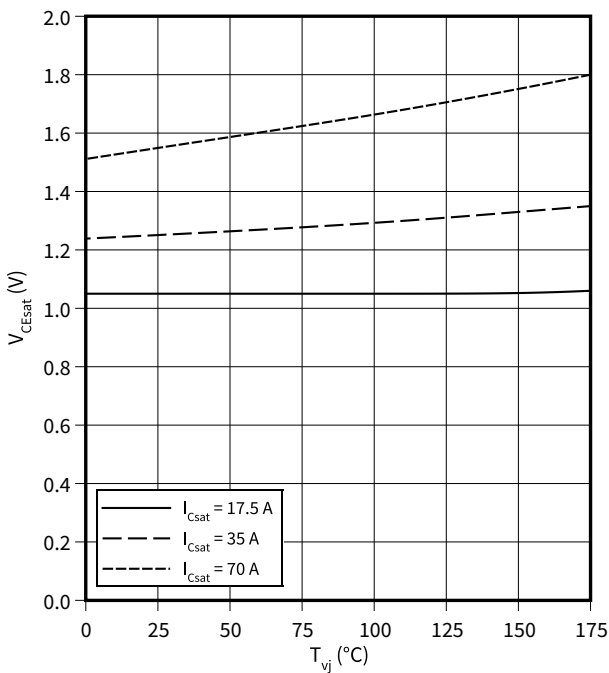
Typical transfer characteristic, IGBT

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



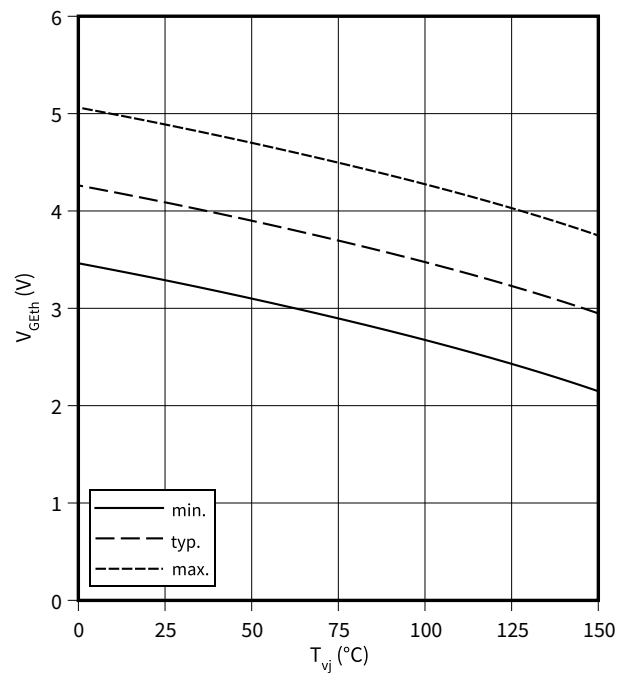
Typical collector-emitter saturation voltage as a function of junction temperature, IGBT

$V_{CEsat} = f(T_{vj})$
 $V_{GE} = 15\text{ V}$



Gate-emitter threshold voltage as a function of junction temperature, IGBT

$V_{GEth} = f(T_{vj})$
 $I_C = 0.70\text{ mA}$

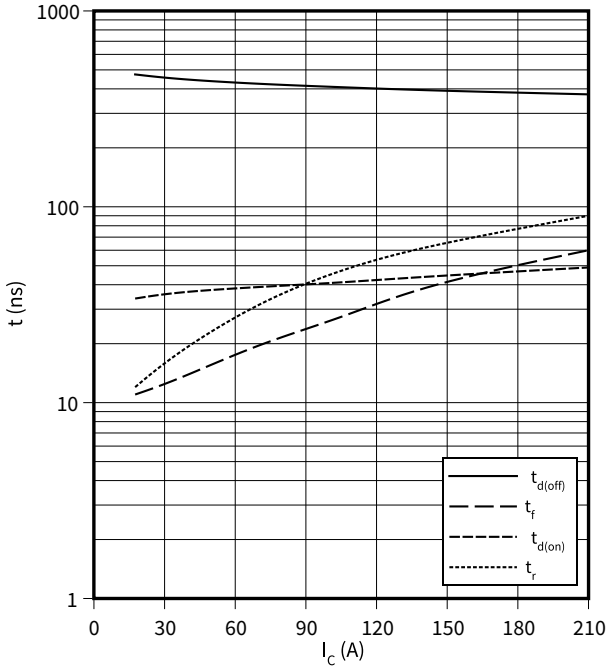


4 Characteristics diagrams

Typical switching times as a function of collector current, IGBT

$t = f(I_C)$

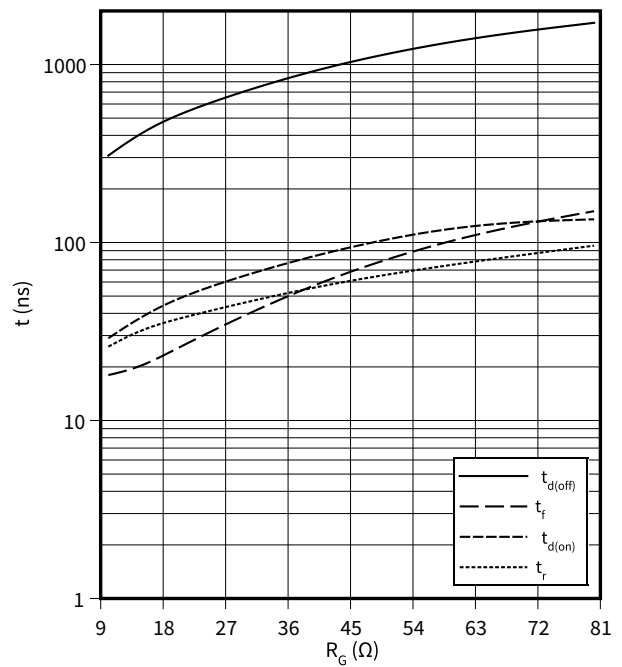
$V_{CE} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}, R_G = 15\text{ }\Omega$



Typical switching times as a function of gate resistor, IGBT

$t = f(R_G)$

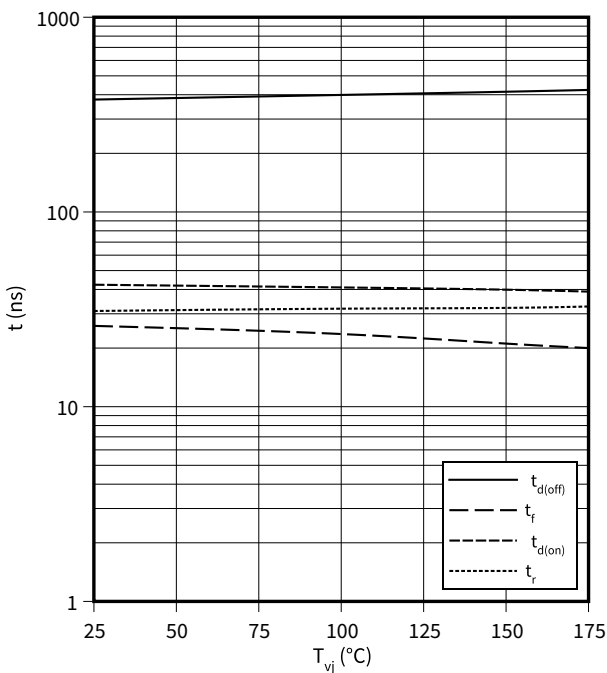
$I_C = 70.0\text{ A}, V_{CE} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}$



Typical switching times as a function of junction temperature, IGBT

$t = f(T_{vj})$

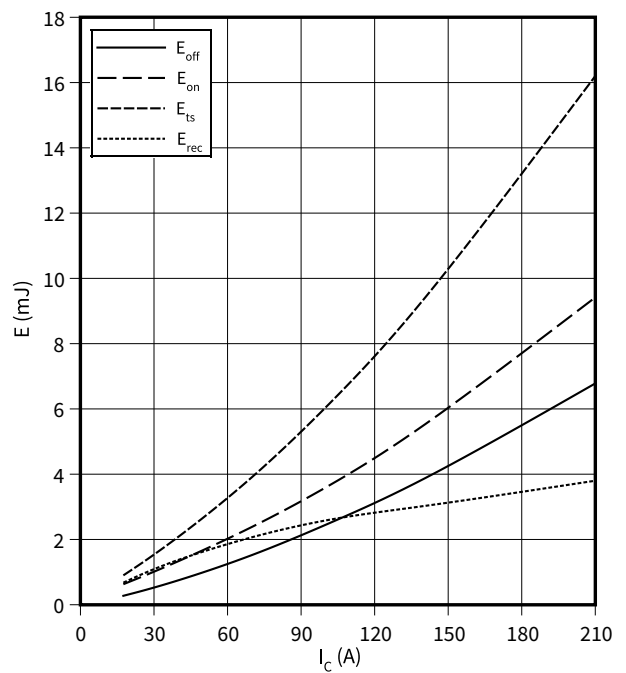
$I_C = 70.0\text{ A}, V_{CE} = 400\text{ V}, V_{GE} = 0/15\text{ V}, R_G = 15\text{ }\Omega$



Typical switching energy losses as a function of collector current, IGBT

$E = f(I_C)$

$V_{CE} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}, R_G = 15\text{ }\Omega$

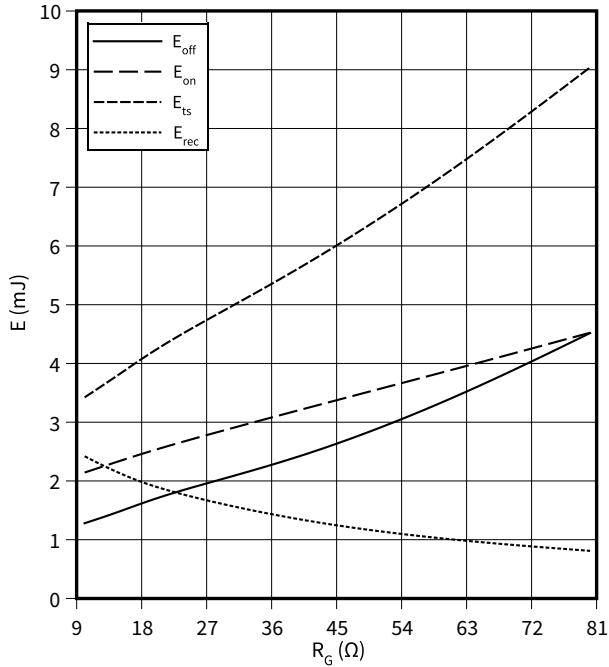


4 Characteristics diagrams

Typical switching energy losses as a function of gate resistor, IGBT

$E = f(R_G)$

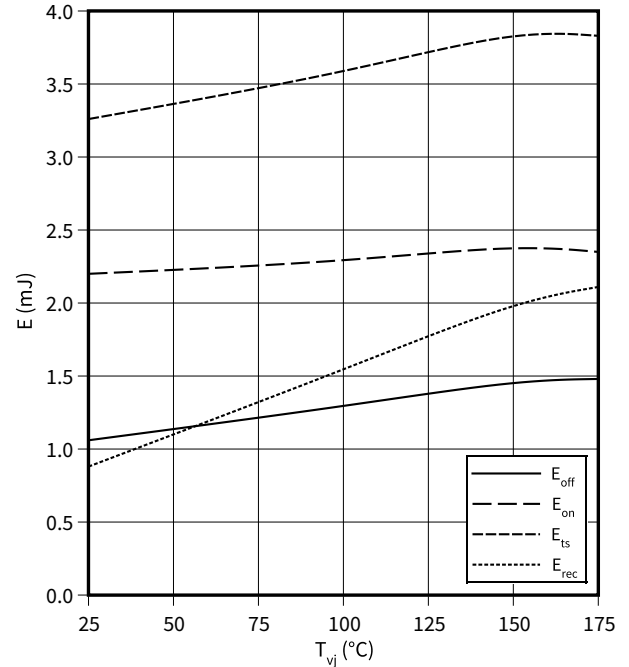
$I_C = 70.0 \text{ A}$, $V_{CE} = 400 \text{ V}$, $T_{vj} = 175 \text{ }^\circ\text{C}$, $V_{GE} = 0/15 \text{ V}$



Typical switching energy losses as a function of junction temperature, IGBT

$E = f(T_{vj})$

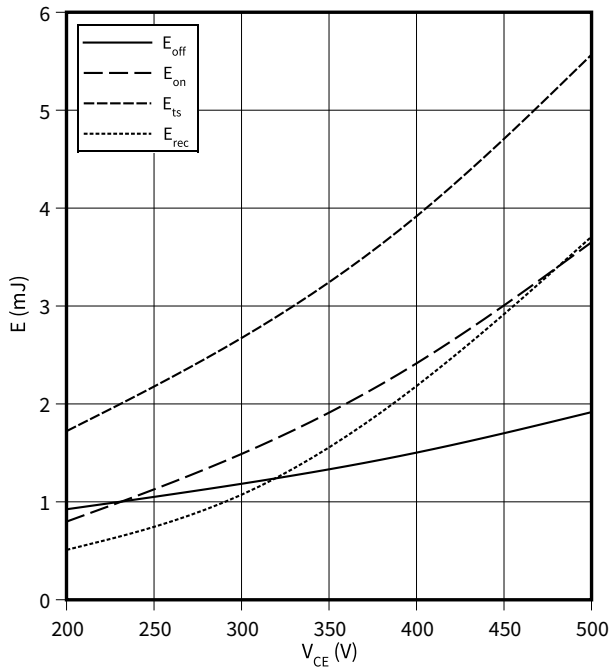
$I_C = 70.0 \text{ A}$, $V_{CE} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 15 \text{ } \Omega$



Typical switching energy losses as a function of collector emitter voltage, IGBT

$E = f(V_{CE})$

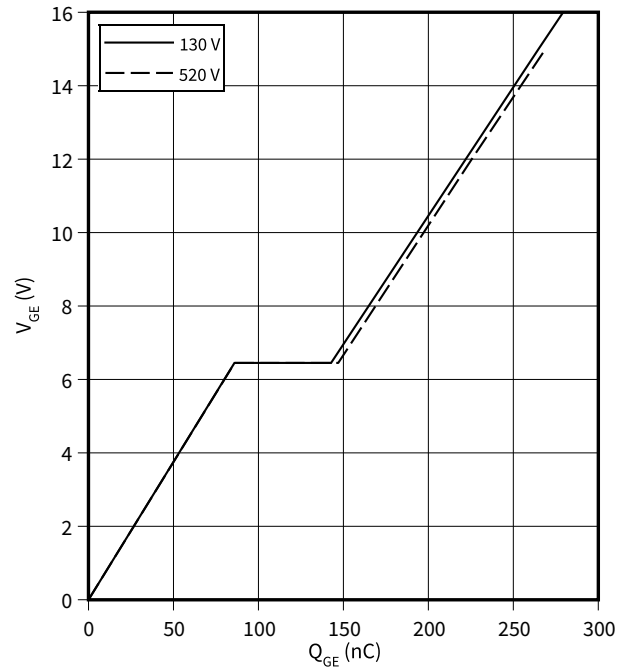
$I_C = 70.0 \text{ A}$, $T_{vj} = 175 \text{ }^\circ\text{C}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 15 \text{ } \Omega$



Typical gate charge, IGBT

$V_{GE} = f(Q_{GE})$

$I_C = 70.0 \text{ A}$

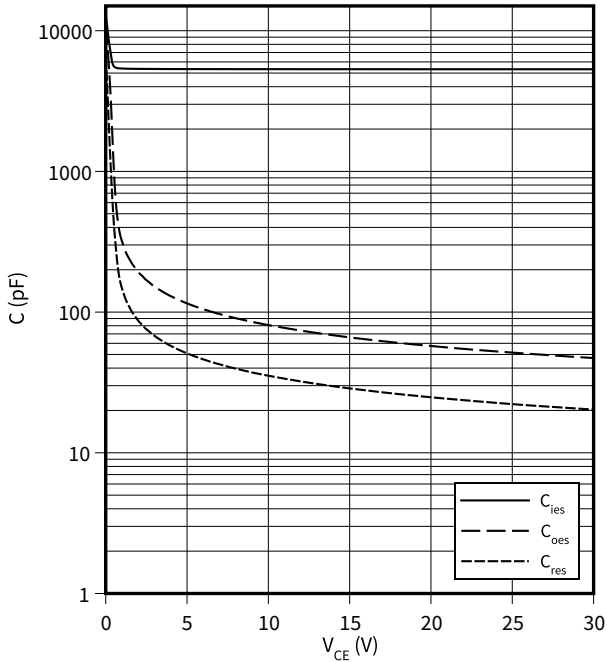


4 Characteristics diagrams

Typical capacitance as a function of collector-emitter voltage, IGBT

$C = f(V_{CE})$

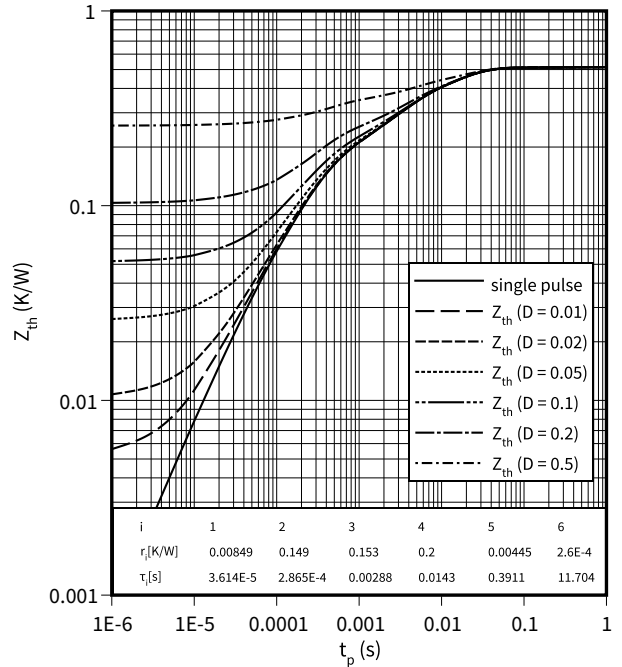
$f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}$



IGBT transient thermal impedance as a function of pulse width, IGBT

$Z_{th} = f(t_p)$

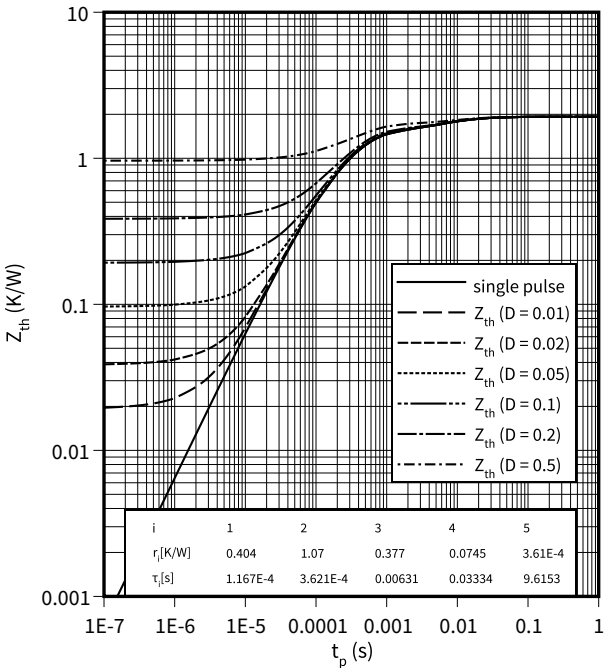
$D = t_p/T$



Diode transient thermal impedance as a function of pulse width, Diode

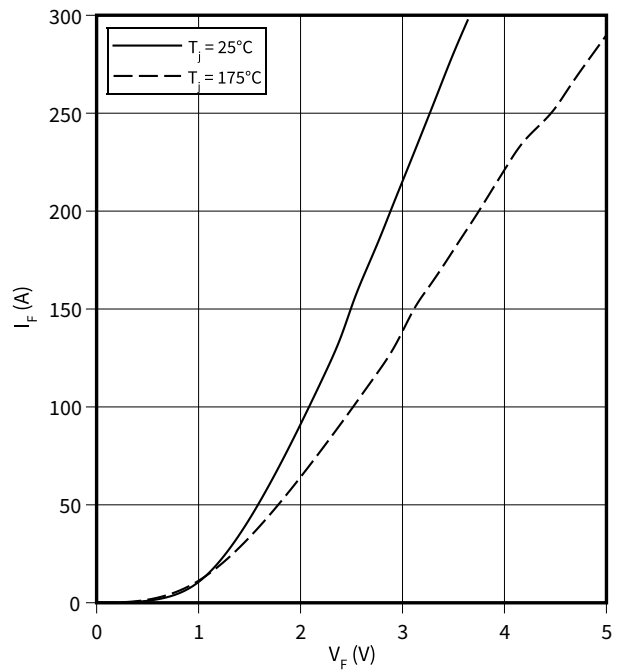
$Z_{th} = f(t_p)$

$D = t_p/T$



Typical diode forward current as a function of forward voltage, Diode

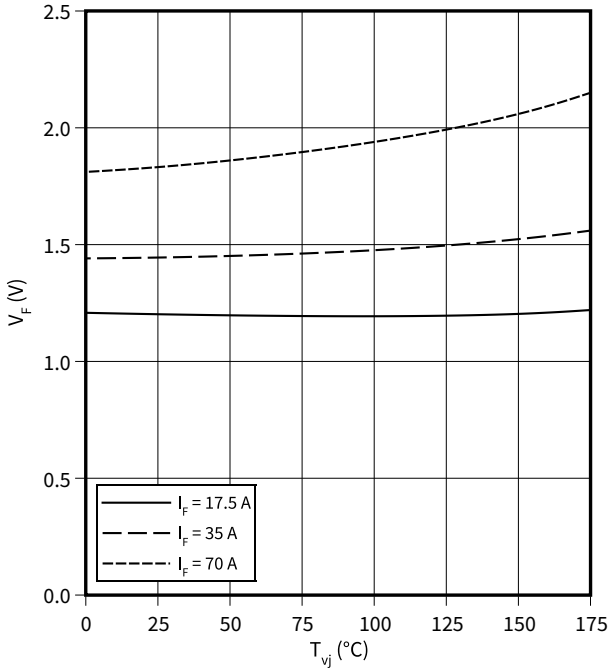
$I_F = f(V_F)$



4 Characteristics diagrams

Typical diode forward voltage as a function of junction temperature, Diode

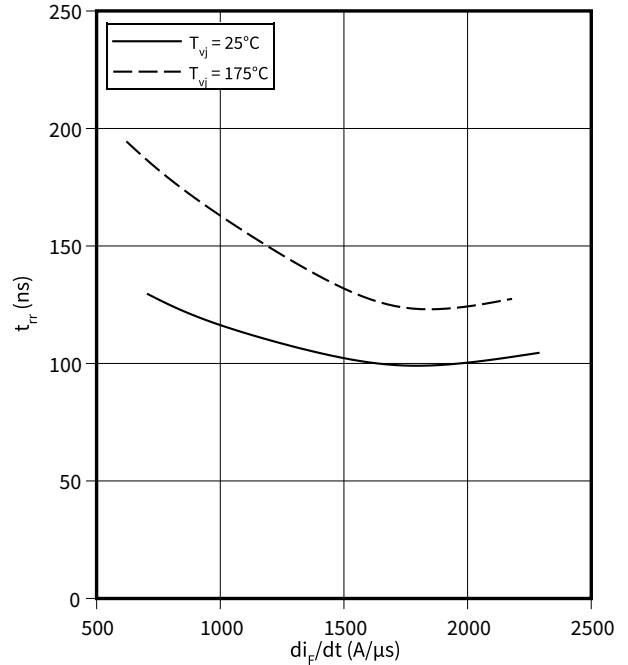
$V_F = f(T_{vj})$



Typical reverse recovery time as a function of diode current slope, Diode

$t_{rr} = f(di_F/dt)$

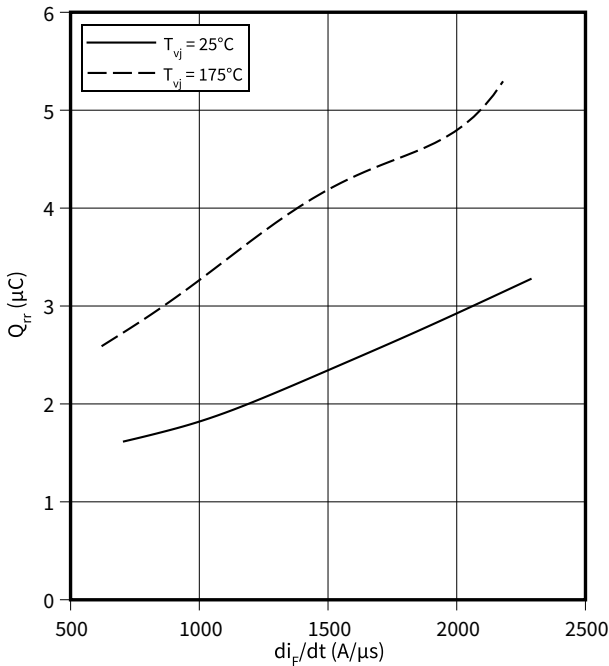
$V_R = 400$ V, $I_F = 35$ A



Typical reverse recovery charge as a function of diode current slope, Diode

$Q_{rr} = f(di_F/dt)$

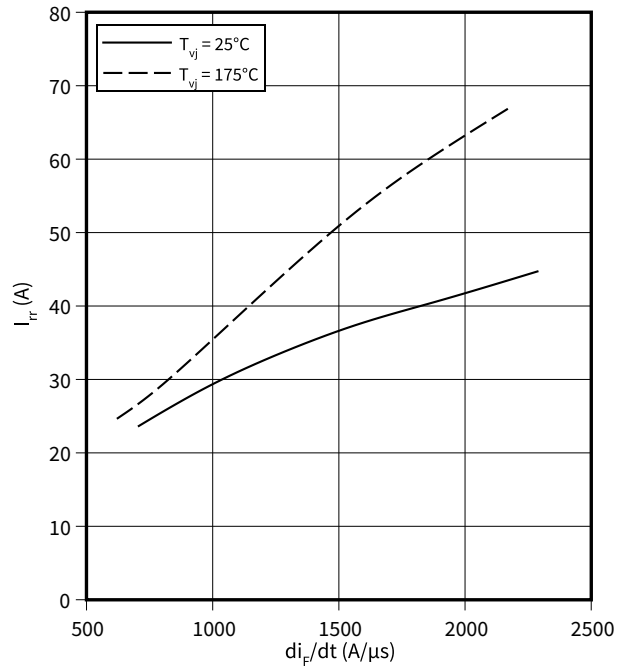
$V_R = 400$ V, $I_F = 35$ A



Typical reverse recovery current as a function of diode current slope, Diode

$I_{rr} = f(di_F/dt)$

$V_R = 400$ V, $I_F = 35$ A

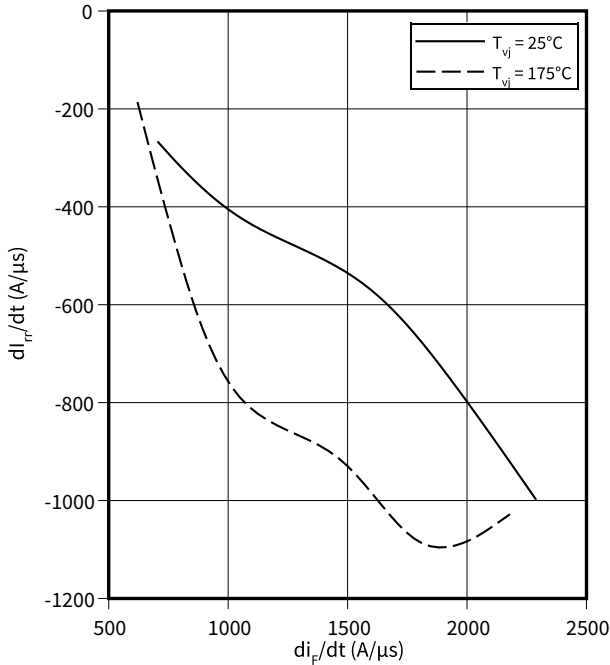


4 Characteristics diagrams

Typical diode peak rate of fall of reverse recovery current as a function of diode current slope, Diode

$di_{rr}/dt = f(di_F/dt)$

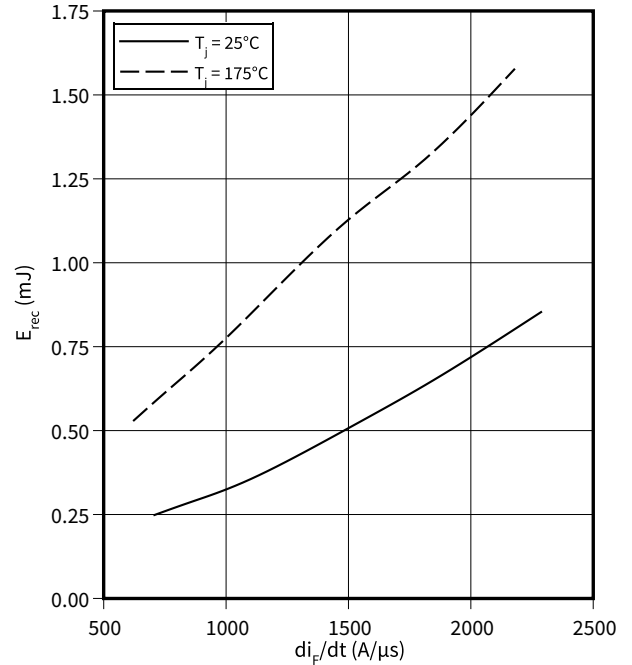
$V_R = 400\text{ V}, I_F = 35\text{ A}$



Typical reverse energy losses as a function of diode current slope, Diode

$E_{rec} = f(di_F/dt)$

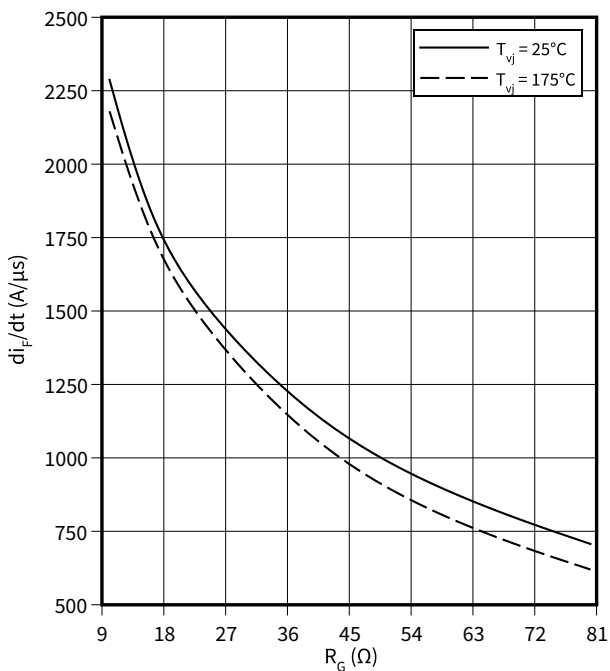
$V_R = 400\text{ V}, I_F = 35\text{ A}$



Typical diode current slope as a function of gate resistor, Diode

$di_F/dt = f(R_G)$

$V_R = 400\text{ V}, I_F = 35\text{ A}$



5 Package outlines

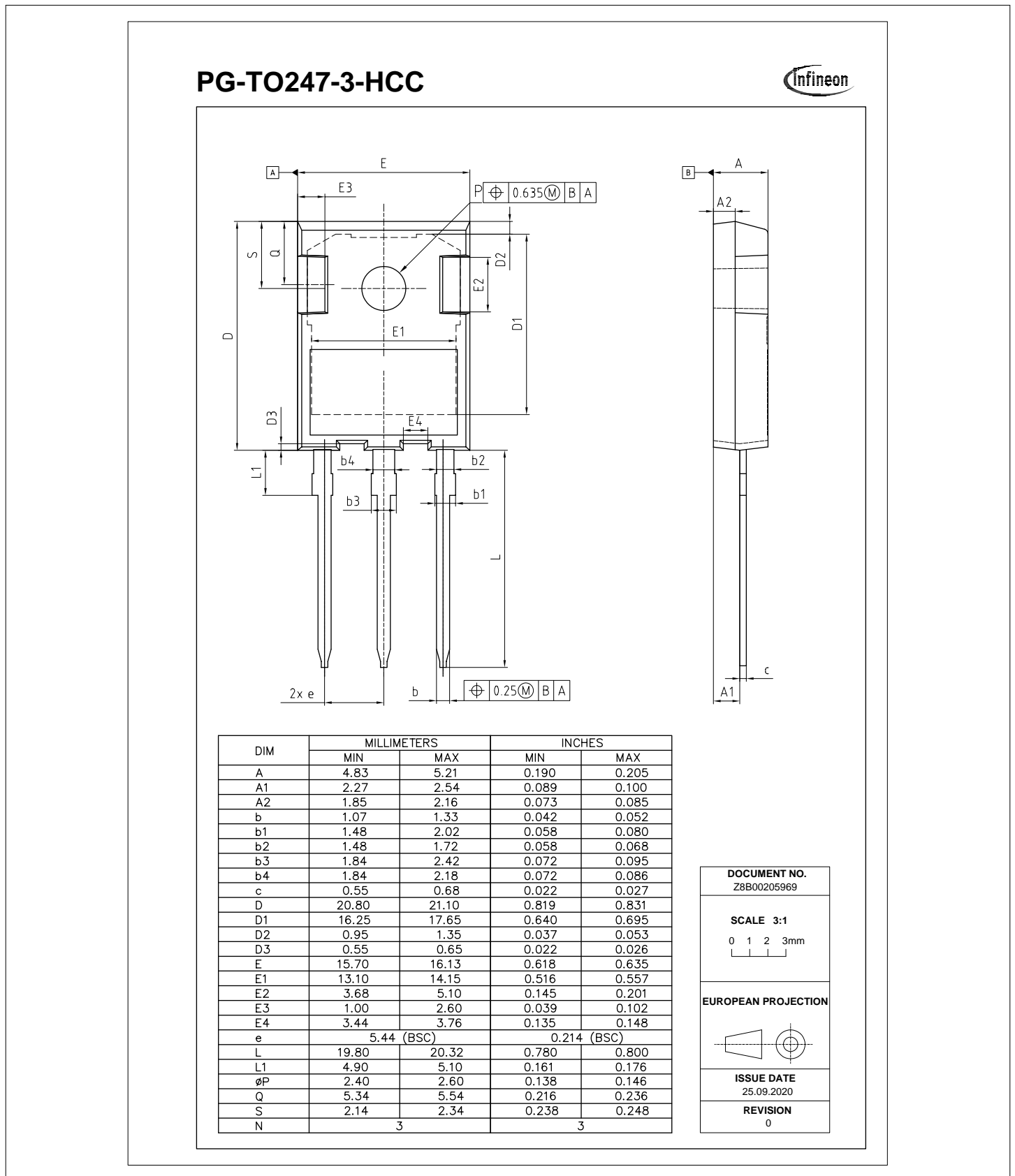


Figure 6

6 Testing conditions

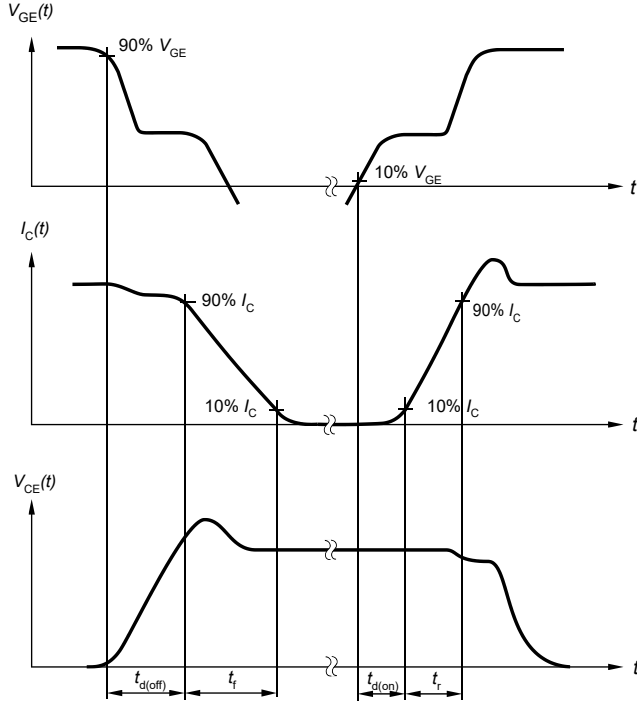


Figure A. Definition of switching times

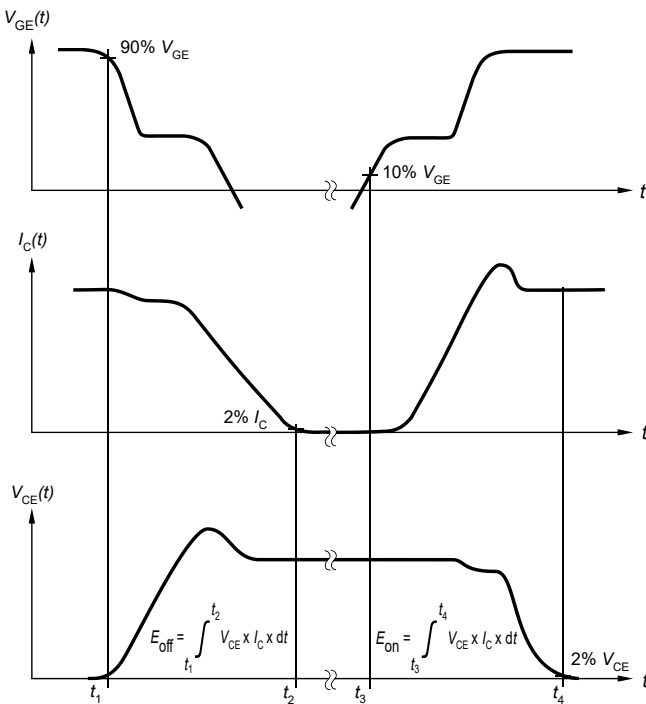


Figure B. Definition of switching losses

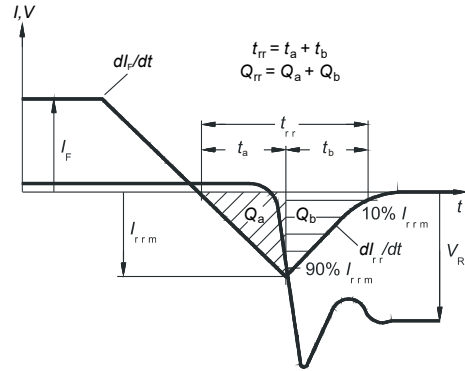


Figure C. Definition of diode switching characteristics

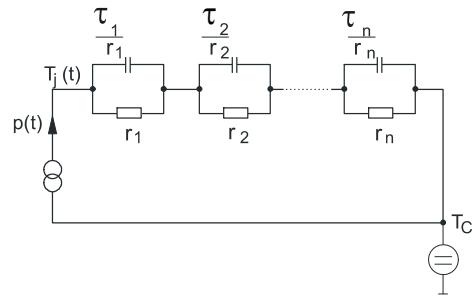


Figure D. Thermal equivalent circuit

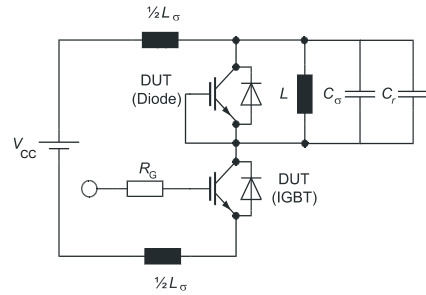


Figure E. **Dynamic test circuit**
 Parasitic inductance L_σ ,
 parasitic capacitor C_σ ,
 relief capacitor C_r ,
 (only for ZVT switching)

Figure 7

Revision history

Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 1.00 | 2021-05-21 | Final datasheet |

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